

Patent Application Transmittal

(only for new nonprovisional applications under 37 C.F.R. 1.53(b))

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> Date: September 27, 1999

Attorney Docket No.: 457020-2250.1

ASSISTANT COMMISSIONER FOR PATENTS Box Patent Application Washington, D.C. 20231

Sir:

With reference to the filing in the United States Patent and Trademark Office of an application for patent in the name(s) of:

Farshad KHORRAMI and Nirod K. DAS

entitled:

AN INTEGRATED MICRO-STRIP ANTENNA APPARATUS AND A SYSTEM UTILIZING THE SAME FOR WIRELESS COMMUNICATIONS FOR SENSING AND ACTUATION PURPOSES

- X Continuing Application
 - X Continuation _ Divisional ___ Continuation-in-Part (CIP) of prior application serial no. 08/806,565 filed February 25, 1997.

[Note: If priority under 35 U.S.C. 120 involves a series of respectively copending applications, then in this amendment identify each and its relationship to its immediate predecessor.]

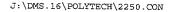
X The prior application is assigned of record to Polytechnic University and Omnitek Research and Development, Inc.

The following are enclosed:

- X Specification (22 pages)
- <u>X</u> 7 Sheet(s) of Drawings
- X 46 Claim(s) (including 6 independent claim(s))
- ___ This application contains a multiple dependent claim
- \underline{X} Our check for $\underline{$1,462.00}$, calculated on the basis of the claims existing in the prior application (less any claims canceled herein) as amended by any enclosed preliminary amendment as follows:

Basic Fee, \$760.00 (\$380.00)	760 00
Number of Claims in excess of 20 at \$18.00 (\$9.00) each: 26	700.00
Name of Telating III excess of 20 at \$18.00 (\$9.00) each: 26	468.00
Number of Independent Claims in excess of 3 at \$78.00 (\$39.00) each: 3	234 00
Multiple Dependent Claim Fee at \$260.00 (\$130.00)	- N -
Total Filing Fee	,462.00

- _ Assignment Recording Fee \$40.00
- This application is being filed within the month following the expiration of the term originally set therefor in the prior application. This is a petition to request a -month extension of time. A check covering the cost of the petition is enclosed.



Patent Application Transmittal

(only for new nonprovisional applications under 37 C.F.R. 1.53(b)) 457020-2250.1

X Oath or Declaration and Power of Attorney

New ___ signed ___ unsigned ___ Copy from a prior application (37 C.F.R. 1.63(d))

Deletion of Inventors

Signed Statement attached deleting inventor(s) named in the prior application (37 C.F.R. 1.63(d)(2) and 1.33(b))

Power of Attorney or Correspondence Address Change

- Power of attorney and/or correspondence address was changed during X prosecution of the prior application. The new power of attorney is to <u>William S. Frommer, Reg. No. 25,506</u>. The new correspondence address is indicated above.
- X Incorporation by Reference (for continuation or divisional application) The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.
- X A Preliminary Amendment is enclosed. (Claims added by this amendment have been properly numbered consecutively beginning with the number next following the highest numbered original claim in the prior application.)
- ___ Cancel in this application original claims ___ of the prior application before calculating the filing fee. (At least one original independent claim must be retained for filing purposes.)
- X New formal drawings are enclosed.

Certified copy of each foreign priority application on which the claim for priority under 35 U.S.C. 119 is based was filed in prior U.S. application serial no. priority document no. A list of said foreign priority application(s) is provided below. Acknowledgement thereof is requested.

Application No. Filed

<u>In</u>

Please charge any additional fees required for the filing of this application or credit any overpayment to Deposit Account No. 50-0320.

Respectfully submitted,

FROMMER LAWRENCE & HAUG LLP Attorneys for Applicants' WILLIAM S. FROMMER

By: Milliam 5. Frommer by John M Reg. No. 25,506 Dennis M. 5MID Reg. NO. 34,930

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Farshad Khorrami et al.

Continuation of

Serial No. : 08/806,565

Filed : Herewith

For : AN INTEGRATED MICRO-STRIP ANTENNA APPARATUS AND A

SYSTEM UTILIZING THE SAME FOR WIRELESS

COMMUNICATIONS FOR SENSING AND ACTUATION PURPOSES

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Date of Deposit September 27, 1999

I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" Service under 37 CFR 1.10 on the date indicated above and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231

(Typed or printed name of person mailing paper or fee)

(Signature of person mailing paper or fee)

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Prior to its examination, please amend the above identified application as follows:

IN THE SPECIFICATION

Page 3: line 2, delete "the apparatus";

line 3, delete "includes";

same line, change "element and" to --, such as a micro-strip

type antenna, --;

line 4, change "being" to --are--;

line 8, after "may" insert --be--;

line 9, change "the substrate" to --a substrate--;

line 13, delete "the";

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line 20, change "microstrip antenna" to --a microstrip

antenna(s)--;

line 22, change "manner instantaneously" to --instantaneous

manner--.

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Page 4: line 10, delete "several antennas";
line 22, after "system" insert --is
provided--.

Page 5: line 16, change "and powering sensors and actuators" to -- and/or powering of such sensors and actuators located on or within a structure--;

line 17, change "structure" to --sensors and actuators--.

Page 11: line 24, after "half" insert --the--.

Page 12: line 1, change "properly situated in order" to --such so as--.

Page 13: line 23, change "Fig. 6" to --Figs. 6A and 6B--.

Page 14: line 2, change "Further" to --More particularly--; same line, change "includes" to --may include--.

Page 15: line 8, change "40" to --410--; line 20, change "is" to --may be--.

Page 16: line 5, change "420" to --410--;
line 14, change "antenna," to

--antenna--.

Page 18: line 7, change "564" to --504--;

line 15, change "This non-linear function" to --The non-linear function of the element 508--.

IN THE CLAIMS

Amend claims 1, 2, 3, and 5-10 by rewriting the same as follows:

--1. (Amended) A wireless communication system comprising:

a number of sensors each having an antenna and being located on or within an element, each [of said sensors] sensor being adaptable to detect [a] at least one respective predetermined characteristic of said element; and

control transceiver means, operable to communicate in a wireless manner with said <u>number of</u> sensors, for supplying <u>a</u> power <u>signal</u> to a desired number of said sensors so as to activate each respective antenna thereof and enable the desired sensor or sensors to detect the respective <u>at least one</u> predetermined characteristic and to transmit an output signal indicative of the detected respective <u>at least one</u> characteristic to said control transceiver <u>means.</u>—

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- --2. (Amended) A wireless communication system as in claim 1, wherein [each said sensor] at least one of said number of sensors includes only passive electronic devices.--
- --3. (Amended) A wireless communication system as in claim 1, wherein [each said sensor] at least one of said number of sensors includes a substrate portion having non-linear material characteristics.--
- --5. (Amended) A wireless communication system as in claim 3, wherein the desired sensor or sensors modulate the power signal and the output signal indicative of the detected respective <u>at least one</u> characteristic and transmits the modulated signal to said control transceiver <u>means</u>.--
- --6. (Amended) A wireless communication system as in claim 1, wherein the <u>at least one</u> predetermined <u>characteristic includes at least</u>
 [characteristics include] one of strain, acceleration, deformation, and pressure.--
- --7. (Amended) A wireless communication system as in claim 1, wherein said control transceiver means communicates with <u>each</u> said <u>sensor</u> [sensors] over a microwave frequency range.--
 - --8. (Amended) A wireless communication system comprising:

a number of actuators each including an antenna and being located on or within an element and being adaptable for causing said element to deform in a desired manner when actuated; and

control transceiver means, operable to communicate in a wireless manner with said <u>number of</u> actuators, for supplying <u>a</u> power <u>signal</u> to a desired number of said actuators so as to activate each respective antenna thereof and enable [said respective number of] <u>the desired actuator or</u> actuators to <u>cause said element to</u> achieve the desired deformation.--

- --9. (Amended) A wireless communication system as in claim 8, wherein [each said actuator] at least one of said number of actuators includes only passive electronic devices.--
- --10. (Amended) A wireless communication system as in claim 8, wherein [each said actuator] at least one of said number of actuators includes a substrate portion having non-linear material characteristics.--

Cancel claim 12.

Amend claim 13 by rewriting the same as follows:

--13. (Amended) A wireless communication system as in claim 8, wherein said control transceiver means communicates with [said] the actuator or actuators over a microwave frequency range.--

Please add the following new claims:

- --14. A wireless communication system as in claim 1, further comprising means for storing the supplied power signal.--
- --15. A wireless communication system as in claim 14, wherein the storing means includes one of a rechargeable battery and a capacitor bank.--
- --16. A wireless communication system as in claim 1, wherein each said antenna is a micro-strip type antenna.--
- --17. A wireless communication system as in claim 8, further comprising means for storing the supplied power signal.--
- --18. A wireless communication system as in claim 17, wherein the storing means includes one of a rechargeable battery and a capacitor bank.--
- --19. A wireless communication system as in claim 8, wherein each said antenna is a micro-strip type antenna.--
- --20. A wireless communication system as in claim 10, wherein the desired actuator or actuators demodulates the received power signal so as to form an actuation signal.--
- --21. A system for monitoring and/or deforming a structure in a desired manner, said system comprising:

a number of devices each including at least one of a sensor and an actuator each having an antenna and being located on or within said structure, in which each said sensor is adaptable for monitoring at least one predetermined characteristic of said structure and each said actuator is adaptable for causing said structure to deform in said desired manner when actuated; and

control means for transmitting a modulated signal to a desired number of said devices in a wireless manner so as to activate each respective antenna thereof and enable each respective sensor to monitor the at least one predetermined characteristic of said structure and enable the respective

actuator or actuators to cause said structure to deform in said desired manner.--

- --22. A system as in claim 21, wherein at least one of said number of devices includes only passive electronic devices.--
- --23. A system as in claim 21, wherein at least one of said number of devices includes a substrate portion having non-linear material characteristics.--
- --24. A system as in claim 23, wherein said substrate portion is a piezoelectric ceramic material.--
- --25. A system as in claim 21, wherein said control means transmits said modulated signal to said desired number of said devices over a microwave frequency range.--
- --26. A system as in claim 21, wherein each said antenna is a microstrip type antenna.--
- --27. A system as in claim 21, wherein the desired device or devices demodulate the received modulated signal so as to form an actuation signal.--
- --28. A system for causing a structure to be deformed in a desired manner, said system comprising:

a number of sensors each having an micro-strip type antenna and being located on or within said structure and being adaptable for measuring at least one predetermined characteristic of said structure;

a number of actuators each having an micro-strip type antenna and being located on or within said structure and being adaptable for causing said structure to deform in said desired manner when actuated;

control means for transmitting a microwave signal in a wireless manner to a desired number of said sensors so as to activate each respective antenna thereof and enable each of said desired number of sensors to provide a sensed signal indicative of the measured at least one predetermined characteristic; and

means for processing each said sensed signal and for supplying each processed signal to appropriate one or ones of the actuators so as to actuate the same and cause said structure to deform in said desired manner.--

- --29. A system as in claim 28, wherein said control means includes transceiver means for communicating in a wireless manner with each sensor and actuator.--
- --30. A system as in claim 29, wherein said transceiver means communicates with each said sensor and said actuator over a microwave frequency range.--
- --31. A system as in claim 28, wherein the processing means is located on or within said structure.--
- --32. A system as in claim 28, wherein the processing means is not located on or within said structure and wherein said processing means transmits each said processed signal to the appropriate one or ones of the actuators in a wireless manner.--
- --33. A system as in claim 28, wherein at least one of said number of sensors and said number of actuators includes only passive electronic devices.--
- --34. A system as in claim 28, wherein at least one of said number of sensors and said number of actuators includes a substrate portion having non-linear material characteristics.--
- --35. A system as in claim 34, wherein said substrate portion is a piezoelectric ceramic material.--
- --36. A system as in claim 28, wherein the at least one predetermined characteristic includes at least one of strain, acceleration, deformation, and pressure.--
- --37. An element for use in a system for monitoring and/or deforming a structure in a desired manner, said element having a single antenna and being located on or within said structure and being adaptable to operate as at least one of a sensor device and an actuator device, in which said element monitors at least one predetermined characteristic of said structure when operating as a sensor device and in which said element causes said structure to deform in said desired manner when operating as an actuator, and, in which a modulated signal is transmitted to said element in a wireless manner so as to activate the antenna thereof and enable said element to monitor the at least one predetermined characteristic of said structure when operating as a sensor

device and enable said element to cause said structure to deform in said desired manner when operating as an actuator.--

- --38. An element as in claim 37, wherein said element is adaptable to operate simultaneously as a sensor device and an actuator device.--
- --39. An element as in claim 38, wherein the antenna is a micro-strip type antenna and wherein said element includes a grating layer.--
- --40. An element as in claim 38, wherein said element includes only passive electronic devices.--
- --41. An element as in claim 39, further having a protective cover layer and a substrate having a slot and a feedline.--
- --42. A system as in claim 26, wherein at least one of said number of devices includes a protective cover layer and a substrate having a slot and a feedline.--
- --43. A system as in claim 28, wherein at least one of said number of sensors and said number of actuators includes a protective cover layer and a substrate having a slot and a feedline.--
- --44. An element for use in a system for monitoring and/or deforming a structure in a desired manner, said element having a single antenna and being located on or within said structure, in which energy is provided to said element from a signal transmitted to said antenna in a wireless manner.--
- --45. An element as in claim 44, further having an energy storage device and wherein energy is supplied to said energy storage device from the transmitted signal for storage thereat.--
- --46. An element as in claim 45, wherein said energy storage device is a rechargeable type storage device.--
- $^{--47}$. An element as in claim 46, wherein said rechargeable type storage device is a thin film battery.--

REMARKS

Claim 12 has been canceled herein. Claims 4 and 11, amended claims 1-3 and 5-10, and new claims 13-47 are in this application.

An early and favorable action on the merits of this application is solicited.

Respectfully submitted,

Frommer Lawerence & Haug LLP Attorneys for Applicants

R₁₇

Dennis M. Smid

Registration No. 34,930 (212) 588-0800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE APPLICATION FOR LETTERS PATENT

Title:

AN INTEGRATED MICRO-STRIP ANTENNA APPARATUS AND A

SYSTEM UTILIZING THE SAME FOR WIRELESS

COMMUNICATIONS FOR SENSING AND ACTUATION PURPOSES

Inventors:

Farshad Khorrami Nirod K. Das

> William S. Frommer Registration No. 25,506 CURTIS, MORRIS & SAFFORD, P.C. 530 Fifth Avenue New York, New York 10036 (212) 840-3333

ABSTRACT OF THE DISCLOSURE

A system utilizing a number of micro-strip antenna apparatus embedded in or mounted on the surface of a structure for enabling wireless communication of sensed and actuation signals. The micro-strip antenna apparatus may include smart materials or other substrates. If only a sensed operation is desired, the micro-strip antenna apparatus may be fabricated from only passive elements or materials. Furthermore, a micro-strip antenna apparatus is provided which enables simultaneous transmission/reception of sensing and actuation signals.

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BACKGROUND OF THE INVENTION

This invention relates to a micro-strip antenna apparatus and a wireless communication system utilizing such apparatus. More particularly, this invention relates to a micro-strip antenna apparatus having a number of antenna elements and arrays integrated with substrates of smart materials, such as piezoelectric devices, and to a system employing such apparatus for enabling wireless communication to and/or from smart structures.

A so-called smart patch may be surface mounted or embedded in a structure (such as helicopter rotor blades, high-speed machinery, and so forth). Such smart patch may include a sensor or sensors, an actuator or actuators, associated electronics, and/or a control circuit. A structure containing one or more smart patches is referred to as a smart structure.

Smart patches in a smart structure may operate as sensors so as to detect a predetermined characteristic (such as strain) of the respective structure. Additionally, such smart patches may operate as actuators so as to cause a predetermined force, torque, or the like, to be imposed on the respective structure. Ultimately, such smart patches may be utilized both as sensors and as actuators.

A significant concern in placing smart patches in or on smart structures involves power delivery and communications thereto. That is, power and/or signal lines are normally provided between each smart patch and a central control or processing device

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so as to enable power to be delivered to a desired number of the smart patches and to enable communication with such smart patches which may involve providing control signals thereto and/or to permit feedback signals to be received therefrom. As is to be appreciated, such use of power and/or signal lines may limit the application wherein smart patches may be effectively utilized, or may make the installation of smart patches into a structure relatively costly and difficult. Furthermore, inclusion of wires and signal lines in a structure may cause structural degradation and therefore rapid fatigue.

The present invention enables smart patches to receive power and/or transmit signals and/or communicate with a central control device without the use of power and/or signal lines. More particularly, in the present invention, smart patches may receive power signals and may communicate with the central control device in a wireless manner over a predetermined frequency range (such as a microwave frequency range). Accordingly, the above-described problems and/or disadvantages associated with power and signal lines may be eliminated with the present invention.

OBJECTS AND SUMMARY OF THE INVENTION

An object of the present invention is to provide a wireless communication system which enables a number of predetermined characteristics of a structure to be detected and a signal indicative of such detection to be supplied from the structure in a wireless manner.

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Another object of the present invention is to provide a wireless communication system as aforesaid wherein the apparatus includes a number of sensors each having an antenna element and being arranged in or on the structure.

A further object of the present invention is to provide a wireless communication system as aforesaid wherein each sensor includes only passive electronic devices. Furthermore, modulation and demodulation of signals may achieved through inherent nonlinear characteristics of the material being utilized as the substrate for the microstrip antenna.

A still further object of the present invention is to provide a wireless communication system as aforesaid wherein a respective number of the smart patches may be actuated to impose a force on the structure so as to cause a desired movement or deformation of the structure.

Yet another objective of the present invention is to enable power to be delivered to a smart structure by way of electromagnetic radiation (possibly in the microwave frequency range). The power delivery is achieved in a wireless manner by way of a control transceiver and microstrip antennas located on the smart patches. The received power signal may be utilized in a substantially manner instantaneously or stored in an energy storage device such as a rechargeable thin-film battery or a capacitor bank or a combination thereof.

Another object of the present invention is to provide a microstrip antenna apparatus for performing simultaneous sensing and actuation operations. In this arrangement, a single antenna may be utilized not only to transmit a signal corresponding to a predetermined characteristic of the structure, but also to receive a power signal or a control signal for actuation operation.

A further object of the present invention is to provide a multi-layer antenna apparatus which may be utilized to achieve a relatively high level of actuation by increasing the amount of power that several antennas may absorb. This arrangement of a plurality of microstrip antennas may be obtained by having several patches on a substrate or having several patches on several vertical layers integrated with the smart material.

A still further object of the present invention is to provide arrangements of multi-layer microstrip antennas which achieve noise immunity and provide environmental protection of the microstrip antenna and the associated electronic circuitry. Furthermore, such multi-layer arrangements may provide relatively good impedance matching which may produce a relatively high efficiency of the microstrip antenna.

In accordance with an aspect of the present invention a wireless communication system which comprises a number of sensors each having an antenna and being located on or within an element. Each of the sensors is adaptable to detect a respective predetermined characteristic of the element. The system further

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comprises a control transceiver device, operable to communicate in a wireless manner with the sensors, for supplying power to a desired number of the sensors so as to activate each respective antenna thereof and enable the desired sensor or sensors to detect the respective predetermined characteristic and to transmit an output signal indicative of the detected respective characteristic to the control transceiver.

The present invention is particularly beneficial in applications where health monitoring is essential and the structure of the device is degraded when wires are attached to the embedded or surface mounted sensors. The invention may also be applied to applications involving rotating machinery and the like where slip rings or other means are necessary to send signals back to a monitoring station.

The present invention enables wireless communication between sensors and actuators and powering sensors and actuators. Power may be delivered to the structure through the utilization of electromagnetic radiation in the radio frequency (possibly microwave) range. To this end, so-called microstrip antennas may be utilized. Such microstrip antennas may receive and transmit power simultaneously; therefore, not only may the power be collected by one antenna for actuation purposes, but also the same antenna may transmit a signal which may be used for structural health monitoring and/or feedback control purposes.

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Microstrip antennas are relatively inexpensive and light-weight and may be utilized as radiating/receiving elements in radar and communication systems. Basically, a microstrip antenna may be fabricated by depositing/printing a small rectangular metallic patch on one side of a dielectric substrate, with the other side completely plated by a conducting plane. microstrip antennas may be fabricated in a variety of other shapes and sizes, such as those which may enable a microstrip antenna to be easily flushed mounted or arranged onto the body of a car, airplane, rotor blades, high speed machinery or the roof of a building. More complex geometries of microstrip antennas with multiple radiating elements, multiple substrate layers, or complex feed structure are obtainable as described herein so as to meet diverse design requirements. Such multilayer configurations can be integrated with electronics and other control circuitry on separate substrate layers that would allow advanced electronic beam steering, digital control and adaptive processing.

Further, the microstrip antenna elements be integrated onto multilayered dielectric-piezoelectric substrates, along with other electronics and feed distribution circuits, for remote actuation and sensing of mechanical systems. The microstrip antennas would allow wireless communication with a distance transmitter. The power received can be used to remotely actuate the piezoelectric material. Furthermore, signals from the local piezoelectric sensors can be communicated via the microstrip DMS.16\POLYTECH\2250.APP 6

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antennas back to the remote station for monitoring and feedback control purposes. Embedded into the body material of a mechanical structure, and properly distributed over the entire body, such integrated designs enable smart structures to be dynamically monitored and controlled for desired performance by wireless means.

The present invention utilizes micro-strip antenna arrays integrated with piezoelectric (or other smart materials) substrates for enabling wireless communication in various applications such as smart structures. Furthermore, the present invention provides a totally passive antenna system which may be used for sensing operations.

The present invention may be utilized in passive (or active) sensing systems such as remote stress monitoring, electronic identification/tagging, security systems, transmission of signals when slip rings are required, and so forth. Additionally, the present invention may be utilized to perform actuation functions, such as in ultra-high accuracy measuring tools and devices, cutting tools, light-weight robotic manipulators, laser and other optical heads and probes, actuation and health monitoring of aircraft wings and rotor blades for helicopters; health monitoring of turbine blades, health monitoring and active vibration isolation for payloads requiring vibration isolation (e.g., microgravity experiments in space), and so forth.

Other objects, features and advantages according to the present invention will become apparent from the following detailed

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description of illustrated embodiments when read in conjunction with the accompanying drawings in which corresponding components are identified by the same reference numerals.

BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a diagram of a smart structure containing smart patches with a wireless communication system according to an embodiment of the present invention;

Fig. 2 is a diagram of the smart structure containing smart patches and a wireless communication system as in Fig. 1 with a particular structure of an associated control system;

Figs. 3A and 3B are diagrams of a microstrip antenna according to an embodiment of the present invention;

Figs. 4A and 4B are diagrams of a microstrip antenna with a two layer piezoelectric-dielectric substrate arrangement according to another embodiment of the present invention;

Fig. 5 is a diagram of a typical smart patch with integrated microstrip antennas, associated electronics, signal processing and control electronics, rechargeable thin-film batteries, and smart material according to an embodiment of the present invention;

Figs. 6A and 6B are diagrams of integrated microstrip antennas with at least one layer of antenna patches, protective radome, and required feed circuits and radio-frequency electronics according to an embodiment of the present invention;

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Fig. 7 is a diagram of a microstrip antenna with a separate feed and electronics layer/substrate which eliminates interference between electronics and radiation according to an embodiment of the present invention;

Fig. 8 is a diagram of a multi-element smart antenna according to an embodiment of the present invention;

Fig. 9 is a diagram of a wireless communication system for sensing characteristics of a structure using a micro-strip sensing antenna according to an embodiment of the present invention;

Fig. 10 is a diagram of a wireless communication system for actuation of a structure using a microstrip actuating antenna according to an embodiment of the present invention; and

Figs. 11A and 11B are diagrams of a simultaneous sensing and actuating antenna for performing sensing and actuation functions according to an embodiment of the present invention.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

Preferred embodiments of the present invention will now be described with reference to the accompanying drawings.

Fig. 1 illustrates a smart structure communication system 10 consisting of a smart structure 16 which includes smart patches 12, such as those shown in Fig. 5 (i.e., an integrated set of sensors, actuators, electronics, signal processing and control hardware, and micro strip antennas). The smart structure communication system also contains a wireless transceiver system

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14 which is adapted to communicate with the smart structure through a transmitting signal 18 and a receiving signal 20. The sensors and actuators in the smart patches 12 may be of active or smart materials such as piezoelectric ceramics. However, other active materials may be used such as electrorestrictive, shape memory alloys, ferro-electrics, bio-polymers and so-forth.

Fig. 2 illustrates the smart structure 16 with the associated smart patches 12 and feedback controllers 15. the feedback controllers is adapted to respectively receive input signals (yi), to perform a predetermined algorithm on the received signals, and to generate output signals (ui) which are supplied to the inputs to the system, such as the actuators on the smart patches of the structure. The feedback controllers may be implemented as part of the smart patches 12 or its action may be communicated through the control transceiver 14. Although the feedback controllers 15 are shown to have a decentralized structure, the present invention is not so limited. That is, the feedback controllers may be configured as a central computer which receives all the sensor signals and communicates back to all the actuators. This may also be achieved by use of the control transceiver. In other words, the processors may be on the smart structure 16 or removed therefrom at a remote location.

Figs. 3A and 3B respectively illustrate top and side views of a micro-strip antenna 30 printed on a dielectric substrate 34. The dielectric substrate 34 has a ground plane 38 as one of its

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faces. The microstrip antenna is excited through probe feed 32 using a coaxial input 36. However, the present invention is not so limited. That is, other types of feed structure such as co-planar feeding may be used. Furthermore, the dielectric substrate 34 is preferably of an active material type such as piezoceramics that be used for either sensing actuation oroperation. Alternatively, other of types smart materials (such electrorestrictive, magnetostrictive, etc.) may also be used. Instead of such single patch antenna, multiple patch antennas may be used on a single substrate as, for example, shown in Fig. 8.

Figs. 4A and 4B respectively illustrate top and side views of a two-layer dielectric-piezoelectric micro-strip antenna arrangement with a dielectric substrate 134 and a PZT (Lead Zirconate Titanate) substrate 135. This arrangement may be used to compensate for undesirable characteristics of the dielectric substrate 34 which reduces the radiation efficiency of the antenna. Such undesirable effects may include strong anisotropy, high dielectric constant, and high frequency losses. Further, instead of such single patch antenna, multiple patch antennas may be used on a single substrate as, for example, shown in Fig. 8.

The dimensions of the antenna 30, the location of the probe feed 32, the thickness and material properties of the substrate 34 determine the proper operation of the antenna. The length of the antenna should be about half effective wavelength for resonant operation. The width and the location of the probe feed

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should be properly situated in order to achieve proper impedance matching for maximum radiation efficiency. The thickness or the dielectric substrates may be selected to obtain the necessary bandwidth. For instance, to achieve an antenna with a 2.6 GHz resonant frequency, a 1.5 cm x 1.5 cm patch may be deposited on a 0.02 inch thick duroid (approximately 2.5 inches x 1.5 inches) bonded to a 0.02 inches thick piezoceramic (PZT 5H - approximately 2.5 inches x 1.5 inches). The probe feed is to be located at 1 millimeter from one edge, centered about the other dimension. For the two-layer arrangement of Fig. 4 the thickness of the individual layers will have to be adjusted for proper radiation while allowing sufficient interaction of the radiation signals with piezoelectric substrate. A computer-aided analysis of the complex geometry may be used for optimum performance. Furthermore, adjustable short stubs (metallic patches) attached to microstrip antenna may be integrated into the design to further fine tune the radiation efficiency.

Fig. 5 illustrates an arrangement of the smart patch 12. As shown therein, such smart patch includes integrated microstrip antenna 30, associated electronics 56 and shield 54, signal processing and control electronics 56 and shield 58, thin-film batteries 60 (which may be rechargeable or non-rechargeable type), and smart material 50 according to an embodiment of the present invention. The smart patch 12 is limited to this arrangement. For example, the smart patch may include multiples of one or more of

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the above elements (e.g., multiple micro-strip antennas). Furthermore, other elements such as a bank of capacitors for storing charge may be included. Additionally, the micro-strip antenna 30 may be an integrated multi-layer type such as that shown in Fig. 6.

A two- or multi-layer antenna structure may be preferable over a single-layer antenna for several reasons. First, producing a microstrip antenna directly on a single-layered piezoelectric be quite difficult and problematic. structure can The high-dielectric constant of a piezoelectric substrate may result in a very low level of input radiation impedance, which can be difficult to match. Second, available piezoelectric substrates may be quite lossy at microwave frequencies, with poor reproducibility of their microwave characteristics. A two-layer arrangement with a dielectric substrate cascaded on top of a piezoelectric substrate minimizes such undesired effects by concentrating a major fraction fields in the dielectric region. In addition, as of the hereinafter discussed, for sensing applications, the two-layer arrangement provides a relatively simple and effective mechanism to combine and modulate the microwave signal across the antenna together with the low-frequency sensing signal across piezoelectric substrate.

Fig. 6 illustrates the integrated microstrip antennas 30 and their associated electronics. As shown therein, such antenna and electronics include three main parts: an antenna module 94, a

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multilayer microwave/radio-frequency circuit module (MMC) 96, and an antenna control module 98. Further, such antenna includes one or multiple layers of antenna patches 82, a protective radome 80, a primary feed network 86, active circuits and secondary feed network 90, and digital/optical control circuits 92. The antenna and primary feed network layers are coupled with each other through slots on the ground planes of an electromagnetic coupling layer 84. Similarly, the primary feed network 86 and the secondary feed network 96 are interconnected using a slotline coupling 88.

Fig. 7 illustrates an arrangement of an antenna 209. As shown therein, such antenna includes a microstrip antenna 210, which is printed on a substrate 204 and protected by a cover layer 202. This antenna arrangement further includes a feed substrate 206 which includes a separate feed and electronics layer/substrate 214 coupled to the antenna layer using a slot 212 etched on a common ground plane 208 between the antenna and the electronic layers. The isolation between feed and electronics layers eliminates interference between electronics and radiation.

Fig. 8 illustrates a multiple antenna patch arrangement. As shown therein, such arrangement includes multiple antenna patches 304, connected with the array input 308 using metal feed lines 306 so as to increase the received power level. Each microstrip antenna element 304 may be configured as in Fig. 4 with a duroid dielectric substrate 300 and a PZT substrate 302. The

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antenna elements 304 may be configured so as to have a single layer arrangement as in Fig.3 or a multilayer arrangement as in Fig.6.

Fig. 9 is a wireless communication system 401 for sensing characteristics of a structure (such as the structure 16) using a micro-strip sensing antenna 411. The sensing antenna 411 is a two-layer design as in Fig. 4. The wireless communication system 401 includes the control transceiver 14, a receiving antenna 406, and a non-linear element 40. The controlling transceiver subsystem includes a radio frequency signal source 400, a transceiver antenna 404, a circulator 402, a non-linear element (such as a diode) 416, a signal amplifier 418, and a signal processor 420. The signal received by the sensing antenna 411 from the microwave signal source 400 may be mixed with the piezoelectric sensing (e.g., vibration) signal by the non-linear element 410. It is to be appreciated that the nonlinear function of element 410 may be performed by the inherent radio-frequency non-linearity of the piezoelectric substrate of the antenna itself.

In Fig. 9, radio (possibly microwave) signal from an oscillator of frequency, $f_{\rm c}$, tuned to the resonant operating frequency of the sensing antenna, is radiated by a suitable antenna at a controlling base unit or the control transceiver 14. The radio signal is received by the sensing antenna at the other end, producing a received (microwave) voltage, $v_{\rm c}$, across the output terminals of the sensing antenna. A sensing voltage, $v_{\rm s}$, is generated across the piezoelectric substrate due to a response of

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the structure (e.g., mechanical vibration of the structure) on which the sensing antenna is mounted. The sensing voltage is added in series to the microwave signal v_c, due to the two-layer substrate arrangement of the sensing antenna. The non-linear element 420, which may be a microwave varactor diode or the substrate material itself, is connected across the antenna output in order to modulate the microwave and piezoelectric sensing signals. The modulated signal is then re-radiated through the same antenna back to the controlling base unit. The antenna at the base unit receives this modulated signal, which is channeled to a separate port through the circulator 402. A part of transmitted oscillator signal is also reflected from the base-station antenna (due to imperfect mismatch of the base station antenna,) and combined and mixed with the microwave-modulated sensing signal using the microwave diode 416. The low-frequency part of the mixed signal contains the sensing information, which is then amplified by the amplifier 418 and processed by the processor 420 for display and evaluation. It is appreciated that by using advanced signal processing, transmitter circuit and antenna design, and increased transmitter power, it would be possible to extendthis sensing technique to large distances (such as several kilometers).

It may be noted, that the vibration of the sensing platform can result in a doppler effect, independent of the smart material (e.g., piezoelectric ceramic) sensing. This doppler

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information, which may have some correlation with the sensing signal, may not be a reliable measure of the internal mechanical For example, a doppler component may not contain information about stress and vibration components in directions perpendicular to the microwave radiation, or large internal stress variation that produces only small physical displacements and vibration. Accordingly, it is preferable to filter the doppler component and background noise in order to clearly detect the If the transmitting radio frequency (f_c) is sensing signal. slightly shifted or perturbed, the corresponding doppler component would shift linearly with the change in the radio frequency; whereas, the sensing signal would remain unaffected by the small change in the radio frequency. This property can be strategically used for suitable signal processing, and enhanced detection and sensing.

The sensing antenna is preferably a passive device, which does not require any battery source for biasing and circuit operation. The only electronic component that may be used in the antenna 411 is a diode. It may be noted that the substrate itself (e.g., piezoceramic) exhibits some radio/microwave non-linearity of its real and/or imaginary part of the dielectric constant. This non-linearity can be effectively used for modulation purposes without the need for any additional electronic components. This would allow the realization of a single passive device without any additional electronics, which would perform radio/microwave

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reception from a remote control station, sensing and modulation with the microwave signal, and re-transmission of the modulated signal for detection at the remote control station.

Fig. 10 is a wireless communication system 501 for actuation of a structure using a microstrip actuating antenna 506. Such system includes a microwave signal source 500, a control signal source 510, a modulator 502, a transmitting antenna 564 and a receiving antenna 506 which is part of an activation antenna 511. A control signal from the control signal source 510 is modulated by a radio-frequency (possibly in the microwave or millimeter wave range) signal from the microwave signal source 500 by the modulator 502 so as to form an activation signal which is transmitted by the transmitter antenna 504. The signal received by the actuation antenna 506 is converted to activation power signal using the nonlinear element 508. This non-linear function can be implemented using an electronic diode or by the microwave non-linearity of a substrate used with the antenna. The substrate for the antenna may be piezoceramic.

In other words, Fig. 10 illustrates a system for performing an actuation operation by use of a wireless or remote The control signal, v_a , is modulated with a microwave carrier signal, v_c , of frequency, f_c , tuned to the resonant frequency of the actuator antenna. The received signal at the actuator antenna is demodulated by a non-linear element. microwave diode may be used for such non-linear function, which DMS·sea

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alternatively may be performed by the microwave non-linearity of the piezoelectric substrate. The demodulated actuation signal, v_a , can then be fed back with some voltage shifting electronics (low power circuits) to the antenna input for actuation of the piezoelectric layer. Suitable DC-RF isolation mechanism may be used to isolate the RF and DC paths. If higher voltage levels are desired, the antenna may be properly designed for high input impedance and suitably matched to the non-linear device and piezoelectric input using microwave planar circuits.

Figs. 11A and 11B respectively illustrate side and top views of a sensing and actuating antenna 601 which is adapted to simultaneously perform both sensing and actuation functions. This device includes a microstrip antenna 602, a protective radome 612, antenna substrate 610, a strip grating layer piezoelectric layer 608, and a back ground plane 614. A non-linear element (such as electronic diode) 604 is used to convert modulated actuation signal to a base-band actuation signal. A feed-through connection 620 is used to short-circuit the antenna and the strip grating layer for the actuation mode of operation, so that the total actuation voltage can be applied across the piezoelectric. substrate 608 for maximum effectiveness. A metal strip line 603 of length D equal to a quarter guide wavelength may be used so that the low-frequency actuation voltage of the antenna is short circuited to the strip grating layer 606 while, as desired, the actuation signal is not short-circuited. For the sensing mode of

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operation, the device uses a polarization direction 616 while a polarization direction 618 is used for actuation mode of operation. The strip grating layer 606 allows the radiation signal to pass through into the piezoelectric layer 608, which can interact and mix with the sensing signal generated by the piezoelectric substrate. However, the actuation signal can not pass through the strip grating layer. The arrangement allows the actuation and sensing functions to be performed independently and simultaneously by the same device without interfering with each other

The antenna 601 shown in Figs 11A and 11B is integrated device that can perform the function of both remote (wireless) sensing and remote actuation. In the sensing mode of operation, the microwave signal from the control base station is transmitted with an E-field polarization perpendicular to the grating strips. For such polarization, the strip grating structure is transparent to the microwave radiation, and therefore the antenna behaves similar to the sensing antenna previously discussed. However, when the device is used for actuation, the microwave actuating signal is transmitted from the base station with an E-field polarization along the grating strips. For this polarization, the strip grating structure behaves like a nearly perfect reflector, and therefore may be replaced by a nearly perfect metal plane, which insulates the bottom piezoelectric substrate from the actuating microwave signal. After the microwave signal is received by the antenna 602, the additional strip-stub

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and diode arrangement connected to the antenna performs the demodulation of the low-frequency actuating signal from the microwave carrier. It may be observed that this demodulated actuating signal voltage (low-frequency signal) on the microstrip antenna 602 is short-circuited to the metal strip-grating layer through a via hole 620. As a result, all the voltage is applied across the piezoelectric substrate for maximum actuation. operation of the antenna is similar to the operation of the sensor or actuator antennas previously discussed. The only difference is that the control transceiver for the sensing operation and that for the actuation operation will have to use distinctly different polarization of radiation. However, they should preferably use different frequencies in order to maintain higher degree of isolation between each other. The microstrip patch antenna should be designed properly such that the dimension along the individual polarization determines the corresponding frequency of operation.

Therefore, microstrip antenna elements may be integrated onto multilayered dielectric-piezoelectric substrates, along with other electronics and feed distribution circuits, for remote actuation and/or sensing of mechanical systems. The microstrip antennas may allow wireless communication with a distance transmitter. As a result, power may be supplied in a wireless manner to a desired number of smart patches so as to actuate the piezoelectric material included in such smart patches, thereby DMS.16\POLYTECH\2250.APP 21

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causing a force, torque, or the like to be imposed on the structure having the smart patches. Additionally, signals indicative of a sensed or detected predetermined characteristic of the structure from local piezoelectric sensors may be communicated via the microstrip antennas back to a remote station for monitoring and feedback control.

An article entitled "Utilization of Microstrip Antenna for Wireless Communication in Smart Structures" by Nirod K. Das et al., (in press), and presented at the NATO workshop on Smart Electronic Structures in Belgium, NATO Headquarters in November 1996 is hereby incorporated by reference.

An article entitled "Active Vibration Damping and Pointing of a Flexible Structure with Piezoceramic Stack Actuators" by F. Khorrami et al., in proceedings of the SPIE 1996 Symposium on Smart Structures and Materials, (San Diego, CA), February 1996 is hereby incorporated by reference.

Although preferred embodiments of the present invention and modifications thereof have been described in detail herein, it is to be understood that this invention is not limited to these embodiments and modifications, and that other modifications and variations may be affected by one skilled in the art without departing from the spirit and scope of the invention as defined by the appended claims.

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WHAT IS CLAIMED IS:

1. A wireless communication system comprising:

a number of sensors each having an antenna and being located on or within an element, each of said sensors being adaptable to detect a respective predetermined characteristic of said element; and

control transceiver means, operable to communicate in a wireless manner with said sensors, for supplying power to a desired number of said sensors so as to activate each respective antenna thereof and enable the desired sensor or sensors to detect the respective predetermined characteristic and to transmit an output signal indicative of the detected respective characteristic to said control transceiver.

- 2. A wireless communication system as in claim 1, wherein each said sensor includes only passive electronic devices.
- 3. A wireless communication system as in claim 1, wherein each said sensor includes a substrate portion having non-linear material characteristics.
- 4. A wireless communication system as in claim 3, wherein said substrate portion is a piezoelectric ceramic material.
- 5. A wireless communication system as in claim 3, wherein the desired sensor or sensors modulate the power signal and the output signal indicative of the detected respective characteristic and transmits the modulated signal to said control transceiver.

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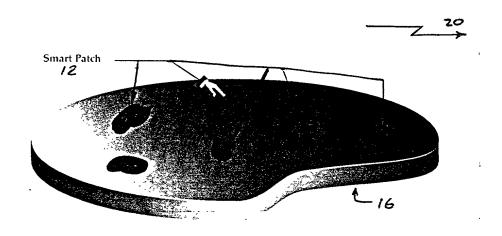
- 6. A wireless communication system as in claim 1, wherein the predetermined characteristics include one of strain, acceleration, deformation, and pressure.
- 7. A wireless communication system as in claim 1, wherein said control transceiver means communicates with said sensors over a microwave frequency range.
 - 8. A wireless communication system comprising:

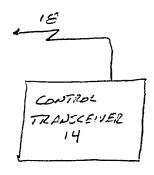
a number of actuators each including an antenna and being located on or within an element and being adaptable for causing said element to deform in a desired manner when actuated; and

control transceiver means, operable to communicate in a wireless manner with said actuators, for supplying power to a desired number of said actuators so as to activate each respective antenna thereof and enable said respective number of actuators to achieve the desired deformation.

- 9. A wireless communication system as in claim 8, wherein each said actuator includes only passive electronic devices.
- 10. A wireless communication system as in claim 8, wherein each said actuator includes a substrate portion having non-linear material characteristics.
- 11. A wireless communication system as in claim 10, wherein said substrate portion is a piezoelectric ceramic material.

- 12. A wireless communication system as in claim 8, wherein the predetermined characteristics include one of strain, acceleration, deformation, and pressure.
- 13. A wireless communication system as in claim 8, wherein said control transceiver means communicates with said actuators over a microwave frequency range.





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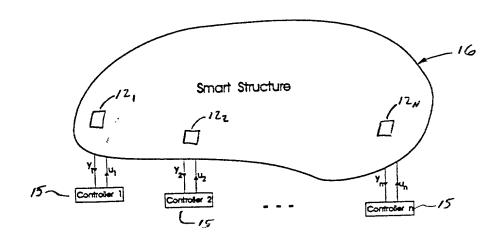
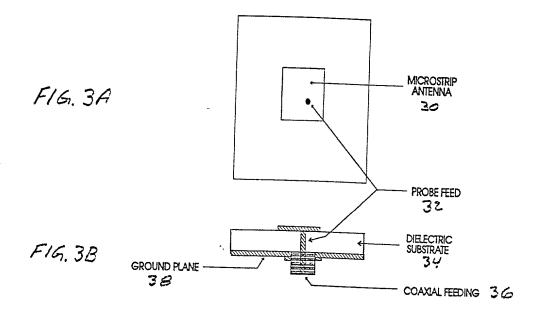
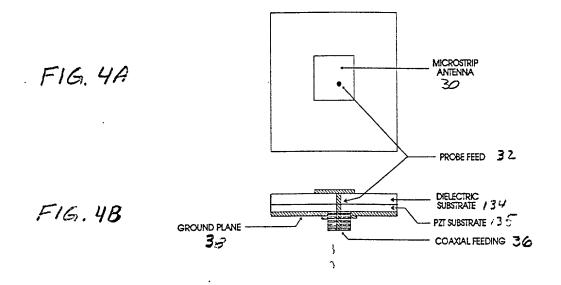
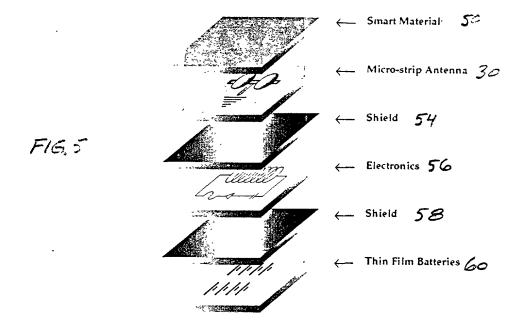
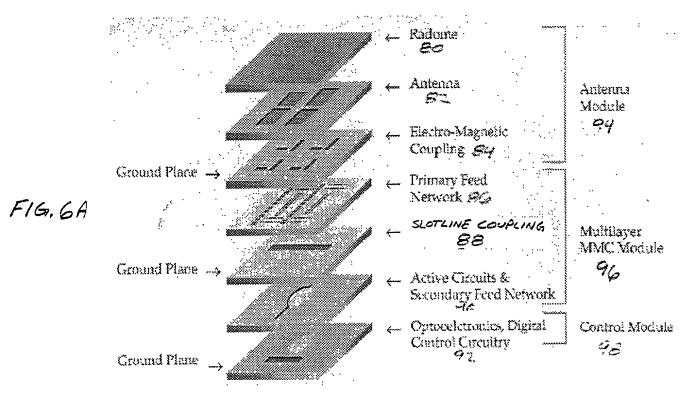


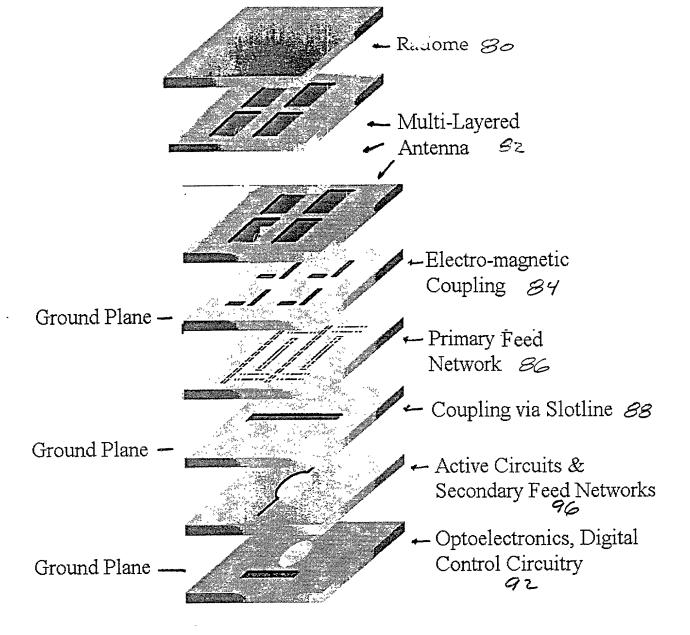
FIG. Z



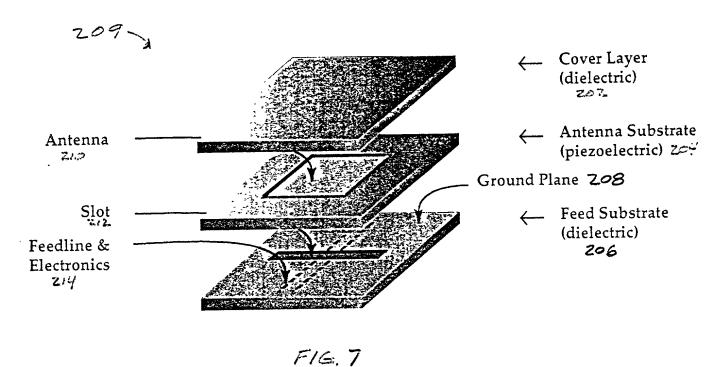


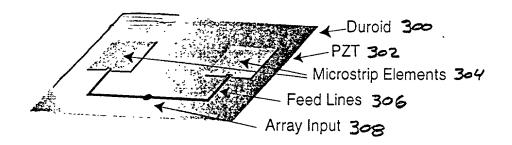




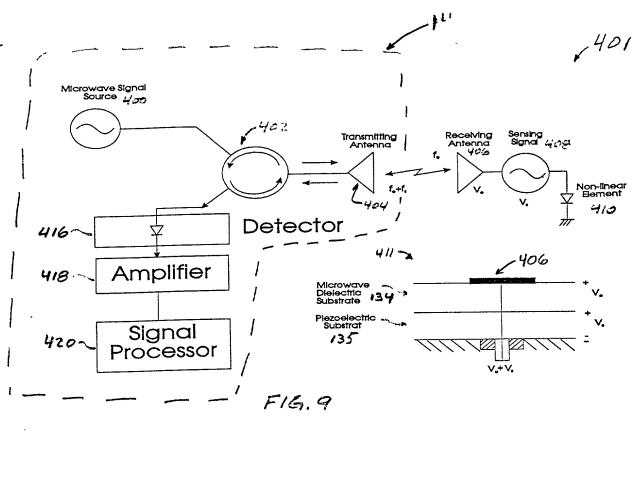


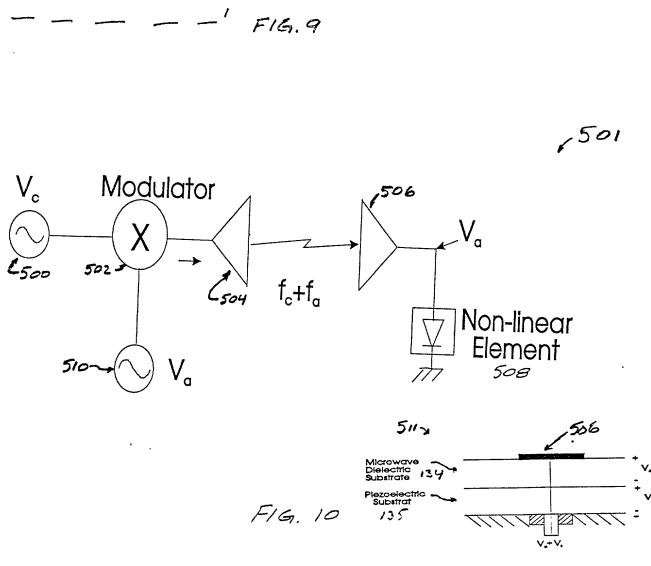
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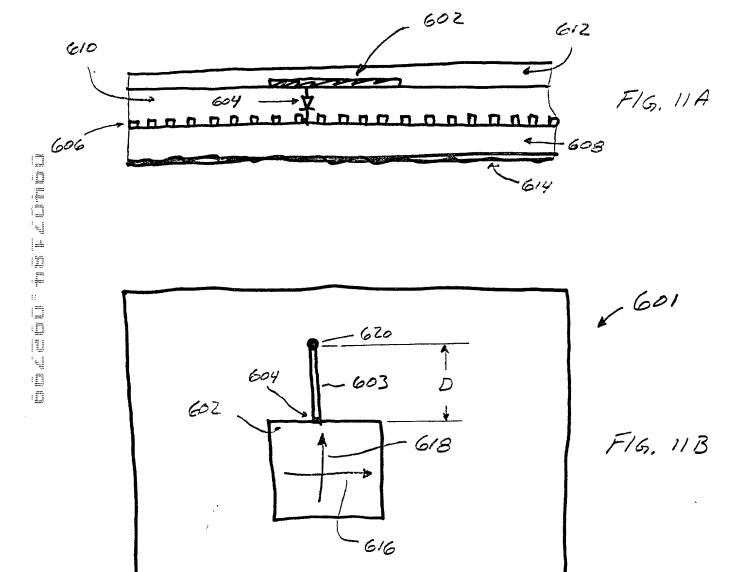




1715. 3







DECLARATION FOR PATENT APPLICATION (JOINT OR SOLE) (Under 37 CFR § 1.63; with Power of Attorney) CURTIS, MORRIS & SAFFORD, P.C. File No. 457020-2250

As a below named inventor, I hereby declare that:
My residence, post office address and citizenship are as stated below next to my name,
I believe I am the original, first and sole inventor (if only one name is listed below) or an
original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed
and for which a patent is sought on the invention ENTITLED:

AN INTEGRATED MICRO-STRIP ANTENNA APPARATUS AND A SYSTEM UTILIZING THE SAME FOR WIRELESS COMMUNICATIONS FOR SENSING AND ACTUATION PURPOSES

VIII.	7.1.0 7.1.0 7.57.7.2511 1 511. 552.5	
the specification of which		
\underline{x} is attached hereto.		
was filed on as Applic	ation Serial No.	
with amendment(s) through	(if applicable, give dates).	
I hereby state that I have reviewed and understage specification, including the claims, as amended by any an \ensuremath{a}		
I acknowledge the duty to disclose to the United known to me to be material to patentability as defined in	States Patent and Trademark Office all information Title 37, Code of Federal Regulations, Sec. 1.56.	
I hereby claim foreign priority benefits under T application(s) for patent or inventor's certificate lists application for patent or inventor's certificate having a which priority is claimed: Prior Foreign Application(s) [list additional application]	a filing date before that of the application on	
Number: Country: Filed (Day/Mont		
I hereby claim the benefit under Title 35, Unite application(s) listed below and, insofar as the subject mot disclosed in the prior United States application in 35, United States Code § 112, I acknowledge the duty to office all information known to me to be material to path Regulations, Sec. 1.56, which became available between the national or PCT international filing date of this application U.S. Application(s) [list additional applications Appln. Ser. No.: Filed (Day/Month/Year):	matter of each of the claims of this application is the manner provided by the first paragraph of Title disclose to the United States Patent and Trademark entability as defined in Title 37, Code of Federal ne filing date of the prior application and the ation:	
I hereby appoint <u>William S. Frommer</u> , Registratio	n No. <u>25,506,</u>	
and CURTIS, MORRIS & SAFFORD, P.C., Registration No. 12,761, or their duly appointed associate, my attorneys, with full power of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to file continuation and divisional applications thereof, to receive the Patent, and to transact all business in the Patent and Trademark Office and in the Courts in connection therewith, and specify that all communications about the application are to be directed to the following correspondence address:		
	Direct all telephone calls	
Willaim S. Frommer, Esq. c/o CURTIS, MORRIS & SAFFORD, P.C.	to: (212) 840-3333 to the attention of: William S. Frommer	
530 Fifth Avenue New York, New York 10036		
I hereby declare that all statements made herein statements made on information and belief are believed t made with the knowledge that willful false statements an imprisonment, or both, under Section 1001 of Title 18 of statements may jeopardize the validity of the application INVENTOR(S):	o be true; and further that these statements were d the like so made are punishable by fine or the United States Code and that such willful false n or any patent issued thereon.	
Signature: H. M. P. T. Full name of sole or first inventor: FARSHAD KHORRAMI Residence: 96 Schermerhorn Street, Brooklyn, New York	_ Date: <u>2/25/97</u> 11201	
Signature: Full name of 2nd Point inventor (if any): NIROD K. DAS Residence: 1-12 Atlantic Avenue, Farmingdale, NY 11735	Date: 2/25/97	
Citizenship: India [Similarly list additional inventors on separate page] Post Office Address(es) of inventor(s):		

Note: In order to qualify for reduced fees available to Small Entities, each inventor and any other individual or entity having rights to the invention must also sign an appropriate separate "Verified Statement (Declaration) Claiming [or Supporting a Claim by Another for] Small Entity Status" form [e.g. for Independent Inventor, Small Business Concern, Nonprofit Organization, individual Non-Inventor].

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